TITLE:

AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SOLUTION FOR CHEMICAL MECHANICAL POLISHING AND METHOD FOR

WANUFACIO	RING COPPER WETAL IN	ERCONNECTION LATER USING THE S	SAIVIE
the specification of which either	is attached hereto or indicates	an attorney docket no. 8021-55 (SS-14743-U	(<u>S)</u> , or:
☐ was filed in the U.S. Patent &	k Trademark Office on	and assigned Serial No	
and (if applicable) was ame	nded on		
claims, as amended by any amento patentability and to the examinal hereby claim foreign priority be or inventor's certificate, or §365	ndment referred to above. I ac nation of this application in acco enefits under Title 35, U.S. Code (a) of any PCT international ap nave also identified below any	e contents of the above-identified specification who knowledge the duty to disclose information wordance with Title 37 of the Code of Federal Rege §119(a)-(d) or §365(b) of any foreign application which designated at least one country foreign applications for patent or inventor's ceclaimed:	which is material gulations §1.56. tion(s) for patent by other than the
		<u>Pr</u>	iority Claimed:
2000-70008	Korea	23 November 2000 Ye	es[X] No[]
(Application Number)	(Country)	(Day/Month/Year filed)	
LE ST TOTAL STATE OF THE STATE	, , , ,	· • •	es [] No []
(Application Number)	(Country)	(Day/Month/Year filed)	[][]
		20 of any United States application(s), or §119(ational application designating the United Stat	
· 5a 0		application is not disclosed in the prior United	
		paragraph of Title 35, U.S. Code, §112, I acknow	
		le 37, The Code of Federal Regulations, §1.56(a	
available between the filing date	of the prior application and the	e national or PCT international filing date of t	this application:
(Application Serial Number)	(Filing Date)	(STATUS: patented, pending, aban	ıdoned)
(Application Serial Number)	(Filing Date)	(STATUS: patented, pending, aban	ndoned)

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; and JAMES J. BITETTO, Reg. No. 40,513; FRANK V. DeROSA, Reg. No. 43,584; GASPARE J. RANDAZZO, Reg. No. 41,528; and SUSAN PAIK, Reg. No. 46,347; each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Frank Chau, Esq. F. CHAU & ASSOCIATES, LLP 1900 Hempstead Turnpike, Suite 501 East Meadow, New York 11554 Area Code: 516-357-0091 I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to boue; and further that these statements were add with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST OR SOL	Citizenship KOREA	
Inventor's signature:	Jong-Wom Lee	Date: Jum 25, 200
Residence & Post Office Address:	603-2006, Hanyang Apt., Yangji Maeul, 29, Sunae-Dong Bundang-gu, Sungnam City, Kyungki-do, Republic of Ko	
	bundang gu, bungnam City, Ryungar do, Republic of Ro	100
FULL NAME OF SECOND INVE	ENTOR: Bo-Un Yoon	Citizenship KOREA
Inventor's signature:	Bo Um Youn	Citizenship KOREA Date: Jun 3, 1m
Residence & Post Office Address:		
FULL NAME OF THIRD INVEN	TOR: Sang-rok Hah	Citizenship KOREA
Inventor's signature:	Song Rok Hah	Date Jun J, 200
Residence & Post Office Address:	S.Fl., Hanju Building, 565-19, Shinsa-dong, Kangnam-gu Seoul, Republic of Korea	
	Scour, Republic of Rorea	
TOTAL CONTROL		
e de la companya de l		
a gene		
CI THE		
Managed offerencys of the Control of		